



Dual USB Overcurrent Switch 1.2A (V_{CC}) / 200mA (V_{SBY})

Features

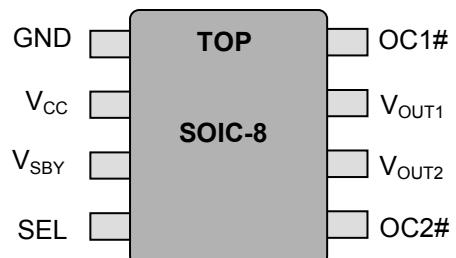
- Dual outputs, each with independent over-current protection circuitry and indicator
- Supports standby mode in PCs so that a peripheral can ramp down safely to a current $<100mA$
- Up to 1.2A (V_{CC}) / 200mA (V_{SBY}) continuous current on each output
- Over-current limits at 1.2A / 200mA respectively
- 10msec min fault blanking delay on OC# outputs prevents false overcurrent alarms
- Prevents backdrive current when host powered off
- Low operating current (95 μ A typ.)
- Small 8-Lead SOIC package

Applications

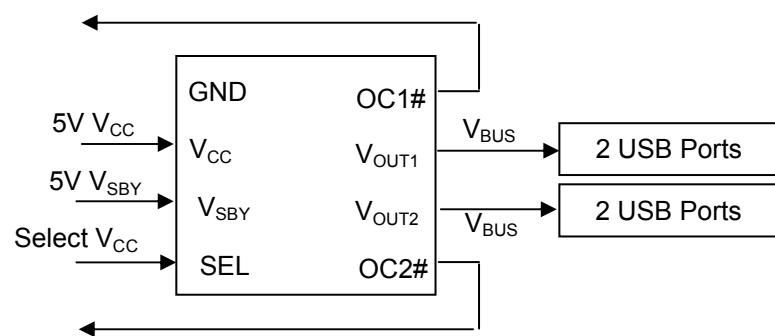
- PC motherboards, Notebooks, Set-Top-Boxes

The CM3511 also prevents backdrive current flowing into the host from the connected peripheral. This can occur when V_{CC} is removed as the host powers down, and the peripheral still has normal power applied. The 5V from the peripheral can therefore be linked to the host's V_{BUS} , potentially causing backdrive current into the host and overloading the peripheral power supply.

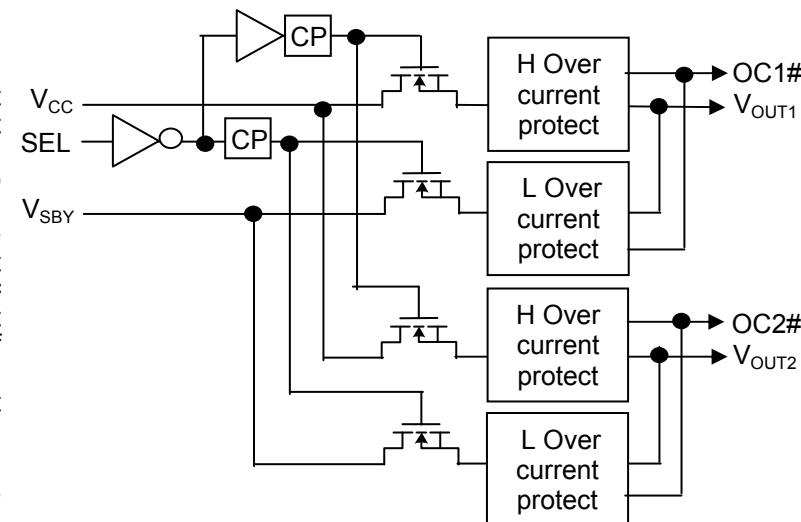
Pin Diagram



Typical Application Circuit



Simplified Electrical Schematic





Absolute Maximum Ratings		
Parameter	Rating	Unit
ESD Protection (All pins, HBM)	± 2000	V
V_{CC} , V_{SBY} Input Voltage	+ 5.6, GND - 0.5	V
Storage Temperature Range	-55 to +150	
Operating Ambient	-40 to +85	$^{\circ}\text{C}$
Operating Junction	-40 to +150*	
Output Current Loading	Internally limited	A
Package Power Dissipation	0.5	W

* - Internally limited

Operating Conditions (unless specified otherwise)		
Parameter	Range	Unit
V_{CC} , V_{SBY} Input Voltage	4.5 to 5.5	V
Ambient Temperature	-40 to +85	$^{\circ}\text{C}$
I_{LOAD} per port	V_{CC} V_{SBY}	0 to 1200 0 to 200
		mA

Electrical Operating Characteristics (over operating conditions unless specified otherwise)						
Symbol	Parameter	Conditions	MIN	TYP	MAX	UNIT
UVLO	V_{CC}/V_{SBY} voltage under which circuit locks out - will not operate			2.2	2.5	V
V_{OUT1} , V_{OUT2}	Output Voltage	$I_{LOAD} = 1000\text{mA}$, $V_{CC} = 5.0\text{V}$, SEL = 5V, $T = 25^{\circ}\text{C}$	4.8			V
R_{SW1}	V_{CC} Switch ON-Resistance	$I_{LOAD} = 0$ to 1200mA; $V_{CC} = 5\text{V}$ $T = 25^{\circ}\text{C}$		0.13	0.20	Ω
R_{SW2}	V_{SBY} Switch ON-Resistance	$I_{LOAD} = 0$ to 200mA; $V_{SBY} = 5\text{V}$ $T = 25^{\circ}\text{C}$		0.7	1.4	Ω
$I_{LIM\ VCC}$	V_{CC} over-current limit	$V_{CC} = 5\text{V}$ SEL = high	1200			mA
$I_{LIM\ VSBY}$	V_{SBY} over-current limit	$V_{SBY} = 5\text{V}$ SEL = low	200			mA
t_{FBD}	Time delay from overcurrent detection to OC# output indication (fault blanking delay)		10	20		ms
T_{MAX}	Temperature at which hot switch turns off during overcurrent			150		$^{\circ}\text{C}$
T_{MIN}	Temperature at which cool switch turns on, after cooling from T_{MAX}			125		$^{\circ}\text{C}$
$I_{R\ CC}$	Reverse leakage from outputs to inputs – backdrive current	$V_{CC} = 0\text{V}$, $V_{OUT} = 5\text{V}$, SEL floating	1			μA
$I_{R\ SBY}$		$V_{SBY} = 0\text{V}$, $V_{OUT} = 5\text{V}$, SEL floating	1			μA
$I_{CC\ ON}$	V_{CC} operating supply current	$V_{CC} = 5\text{V}$, $V_{SBY} < V_{CC}$, SEL = high,	95			μA
$I_{SBY\ OFF}$	V_{SBY} standby supply current	$I_{LOAD} = 0\text{mA}$		1		μA
$I_{SBY\ ON}$	V_{SBY} operating supply current	$V_{SBY} = 5\text{V}$, $V_{SBY} > V_{CC}$, SEL = low,	95			μA
$I_{CC\ OFF}$	V_{CC} standby supply current	$I_{LOAD} = 0\text{mA}$		1		μA
$I_{CC\ H\ Q}$	V_{CC} higher, quiescent current			40		μA
$I_{SBY\ L\ Q}$	V_{SBY} lower, quiescent current	$V_{CC} = 5\text{V}$, $V_{SBY} < V_{CC}$, SEL floating		1		μA
$I_{CC\ L\ Q}$	V_{CC} lower, quiescent current			1		μA
$I_{SBY\ H\ Q}$	V_{SBY} higher, quiescent current	$V_{CC} = 5\text{V}$, $V_{SBY} > V_{CC}$, SEL floating		40		μA
V_{IH-EN}	EN# input Logic-1 threshold	$V_{CC} = 5\text{V}$	2			V
V_{IL-EN}	EN# input Logic-0 threshold	$V_{CC} = 5\text{V}$			0.8	V
I_{OHZ-OC}	OC# output OFF state leakage	$V_{CC} = 5\text{V}$, $V_{OUT} = 5\text{V}$			1.0	μA
V_{OL-OC}	OC# output Logic-0 threshold	$I_{OC} = 1\text{mA}$ to V_{CC}			0.4	V

Note: the internal supply current is taken from whichever input (V_{CC} or V_{SBY}) is higher.



Pin Functions

V_{CC} is the higher current power source. Whenever the SEL pin is above 2V it will be selected, and V_{SBY} will be deselected.

V_{SBY} is the lower current power source. Whenever the SEL pin is below 0.8V it will be selected, and V_{CC} will be deselected. The two V_{SBY} power switches can only supply 200mA each.

Note that the internal supply current (95 μ A typ.) will be taken from whichever input supply pin (V_{CC} or V_{SBY}) is higher.

V_{OUT1} provides the power for a USB port. The internal MOSFET switches are designed for low voltage drops from the voltage input pins at their full rated currents.

V_{OUT2} provides the power for a second USB port. The internal MOSFET switches are designed for low voltage drops from the voltage input pins at their full rated currents.

Current loads of up to 1.2A are allowed (sourced from V_{CC}).

Current loads above 1.2A may cause the constant-current limiting circuit to operate – reducing the output voltage.

Continuous over-current loads will cause the part's internal temperature to rise. If the internal temperature exceeds 150°C then any switch that is in overcurrent mode will be immediately turned off. Any switch that is not in overcurrent mode will remain on – it will not be affected by the over-temperature detection. Once the part has cooled to 125°C then the switch or switches that were in overcurrent mode will be automatically turned on again.

During the cold-start interval when the input is initially applied, internal circuitry provides a soft turn-on for the switches, which limits peak in-rush current.

SEL is the 3-level logic input pin that is used to control which of the power switch pairs are turned on. Set SEL high to select V_{CC}, set SEL low to select V_{SBY}, or allow SEL to float to deselect both power switches. The external device driving the SEL pin must be able to source and sink 100 μ A while maintaining the proper V_{IL}/V_{IH} levels.

OC1#, OC2# are independent, active low open-drain outputs, indicating an overcurrent fault condition has been detected at V_{OUT1} or V_{OUT2}. There is a built-in 10msec (min.) fault blanking period after the overcurrent fault condition has been detected, before these outputs become active. The OC# outputs become deasserted only when both the overcurrent condition stops and when the voltage drop across the switch is less than 1V. External pull-up resistors of 10k - 100k are required if the OC# outputs are used.

Because they are open-drain, the two OC# outputs can be shorted together to make one OC# signal.

GND is the negative reference for all voltages.

Pin Functions		
Pin No.	Symbol	Description
1	GND	Negative reference for all voltages.
2	V _{CC}	High current positive supply input.
3	V _{SBY}	Standby positive supply input. Also provides internal power.
4	SEL	3-level logic input. High = V _{CC} , Low = V _{SBY} , Floating = both off
5	OC2#	Active low when V _{OUT2} is in overcurrent mode.
6	V _{OUT2}	Output voltage internally switched to either V _{CC} or V _{SBY} input source.
7	V _{OUT1}	Output voltage internally switched to either V _{CC} or V _{SBY} input source.
8	OC1#	Active low when V _{OUT1} is in overcurrent mode.

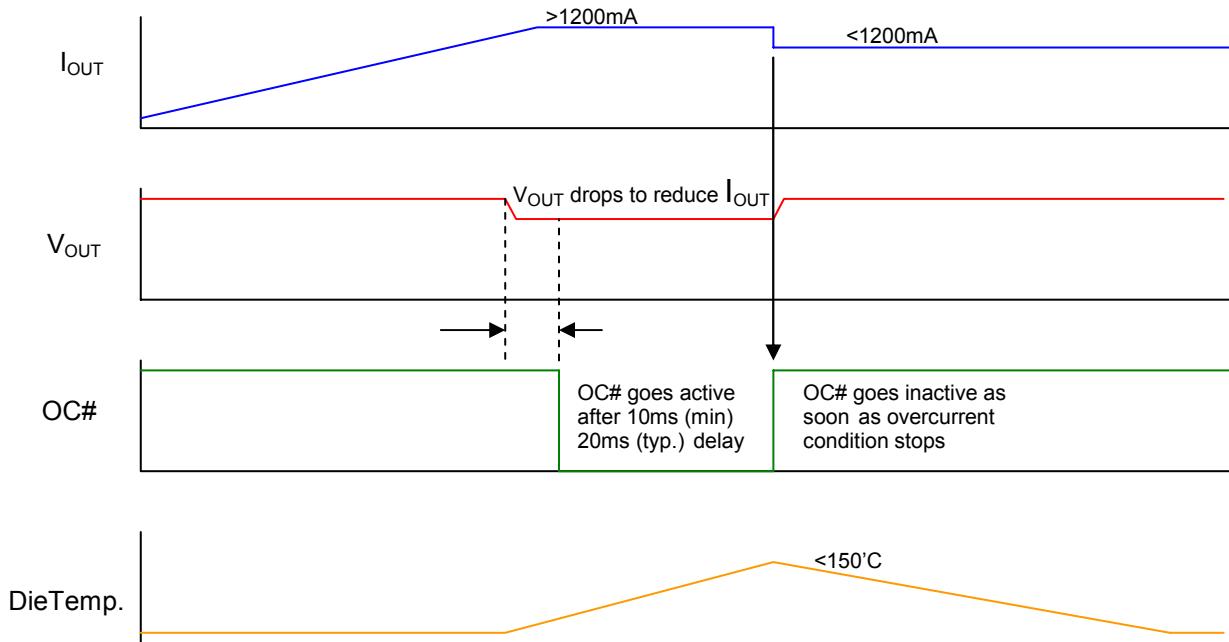
STANDARD PART ORDERING INFORMATION

Pins	Package	Ordering Part Number ¹	Part Marking
8	SOIC	CM3511-04SN	CM3511-04SN

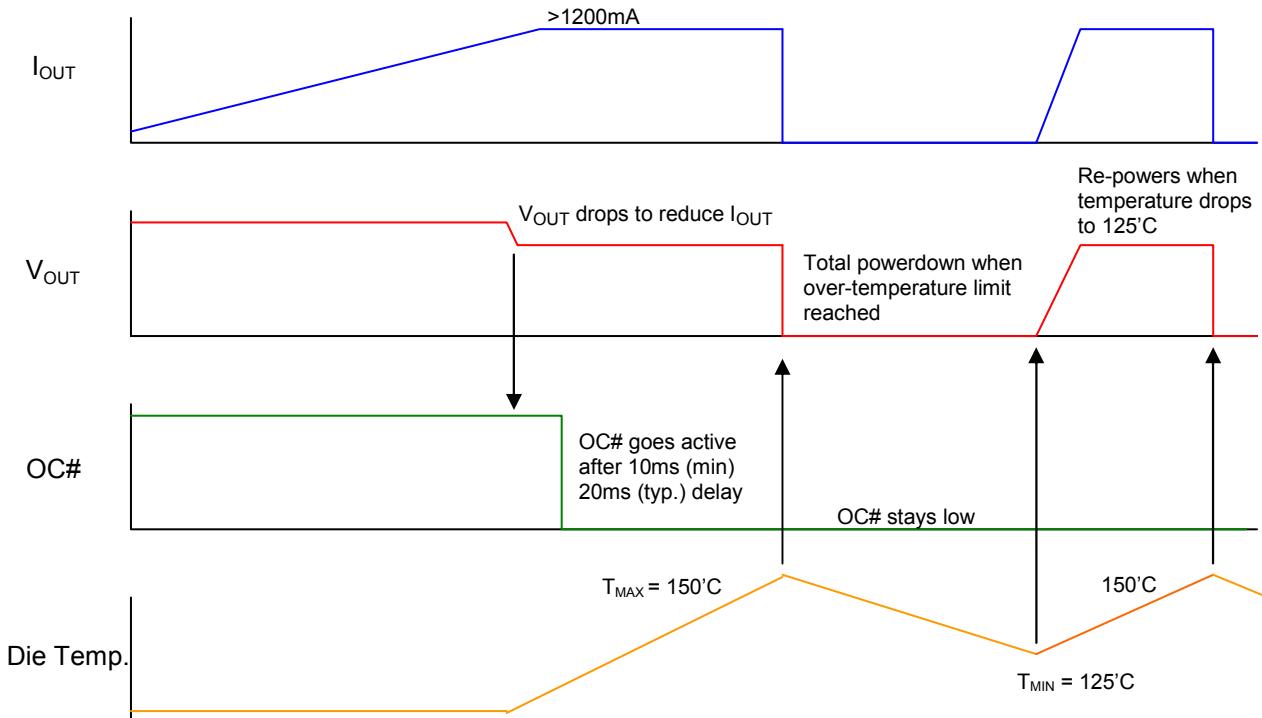


Note 1: Parts are shipped in Tape & Reel form unless otherwise specified.

OC# Response to Momentary Overcurrent Fault



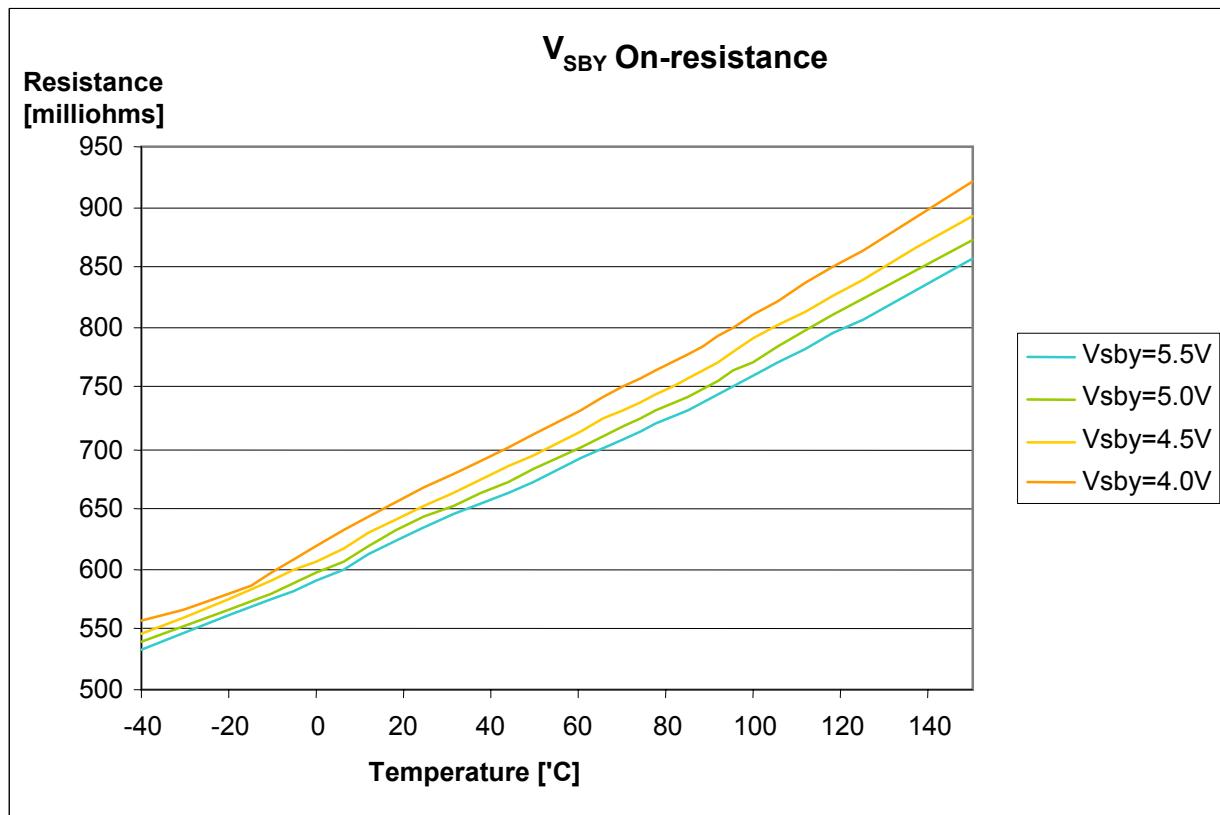
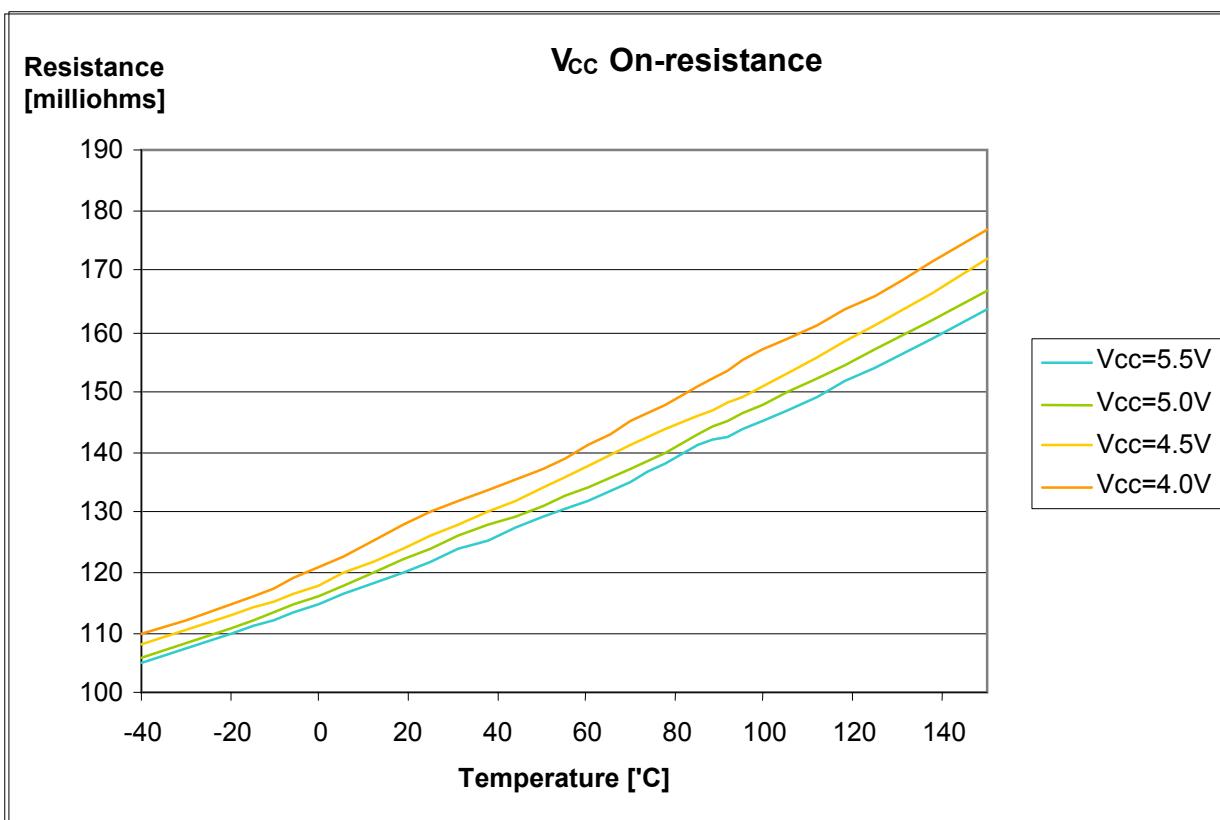
OC# Response to Continuous Overcurrent Fault

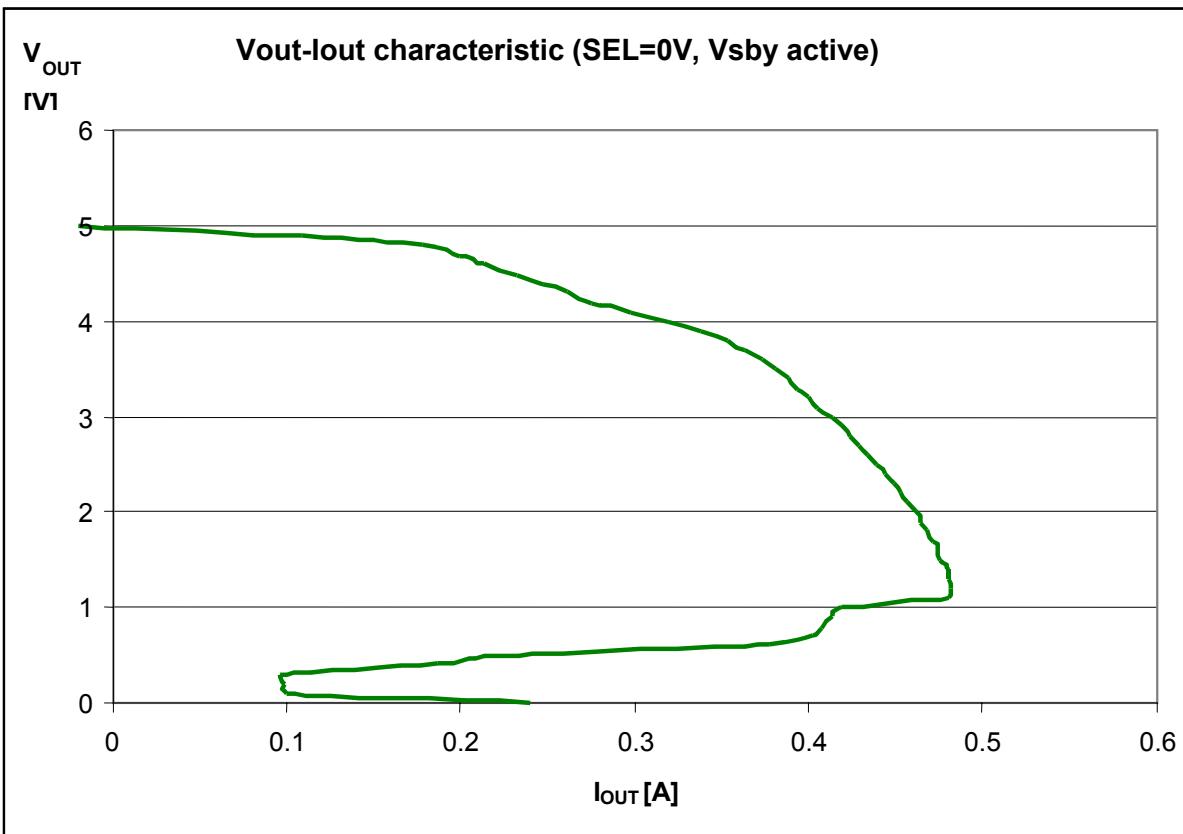
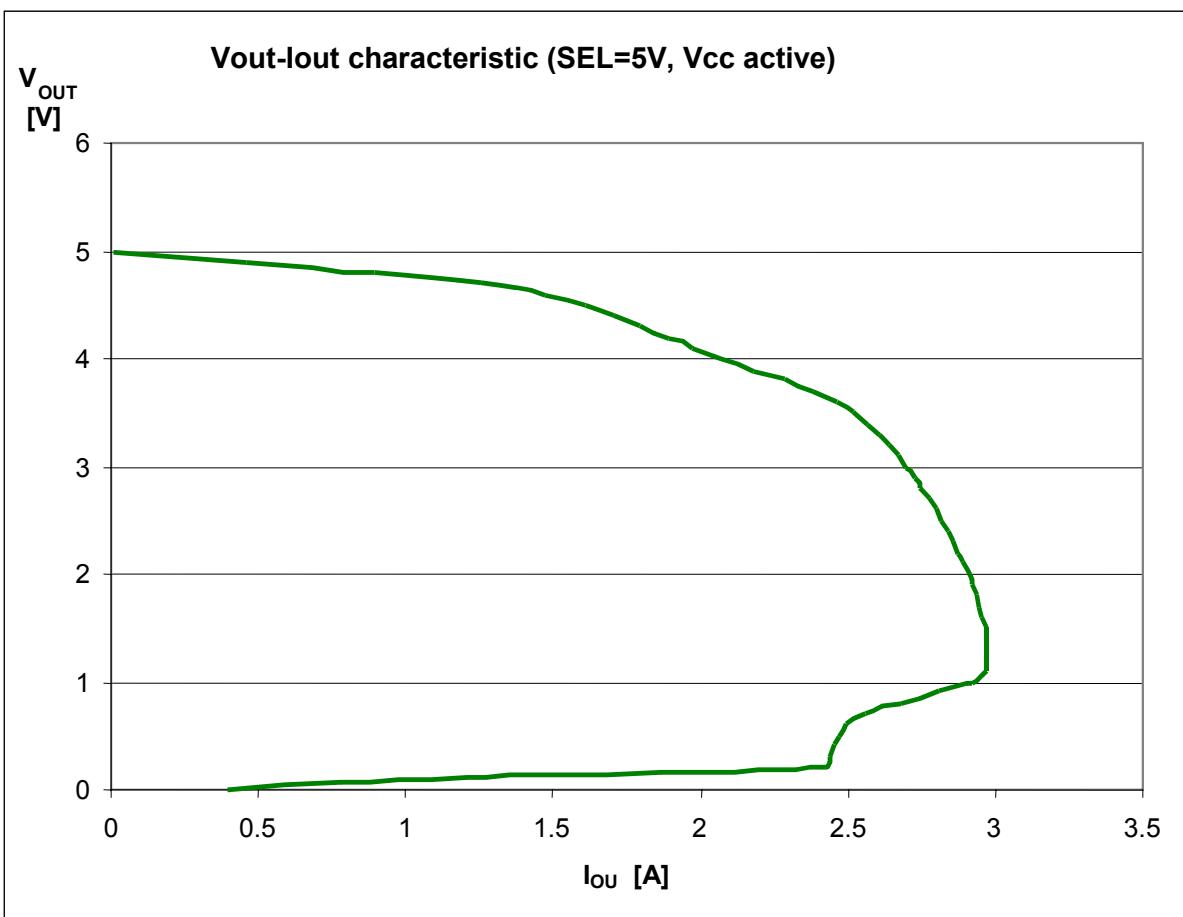


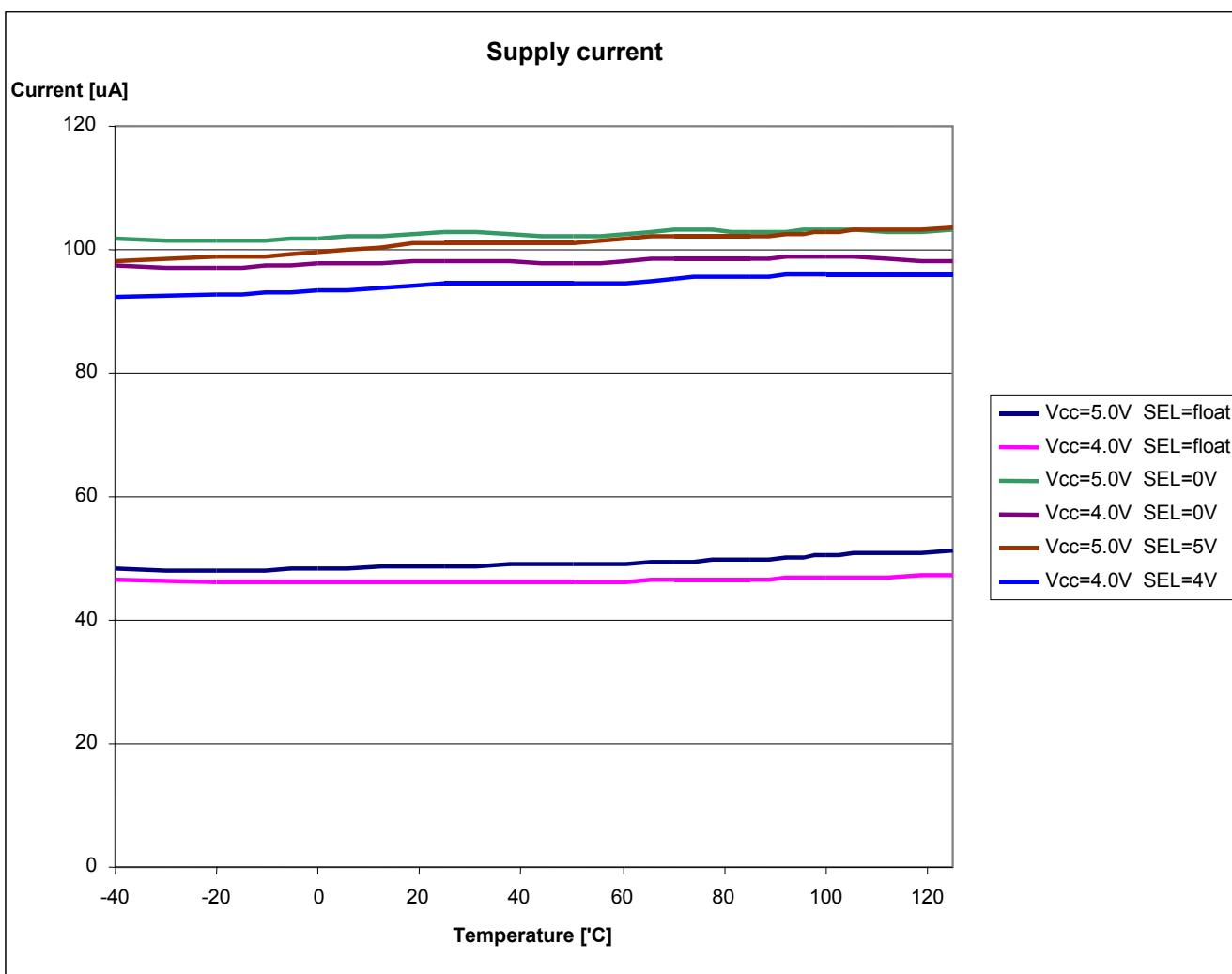
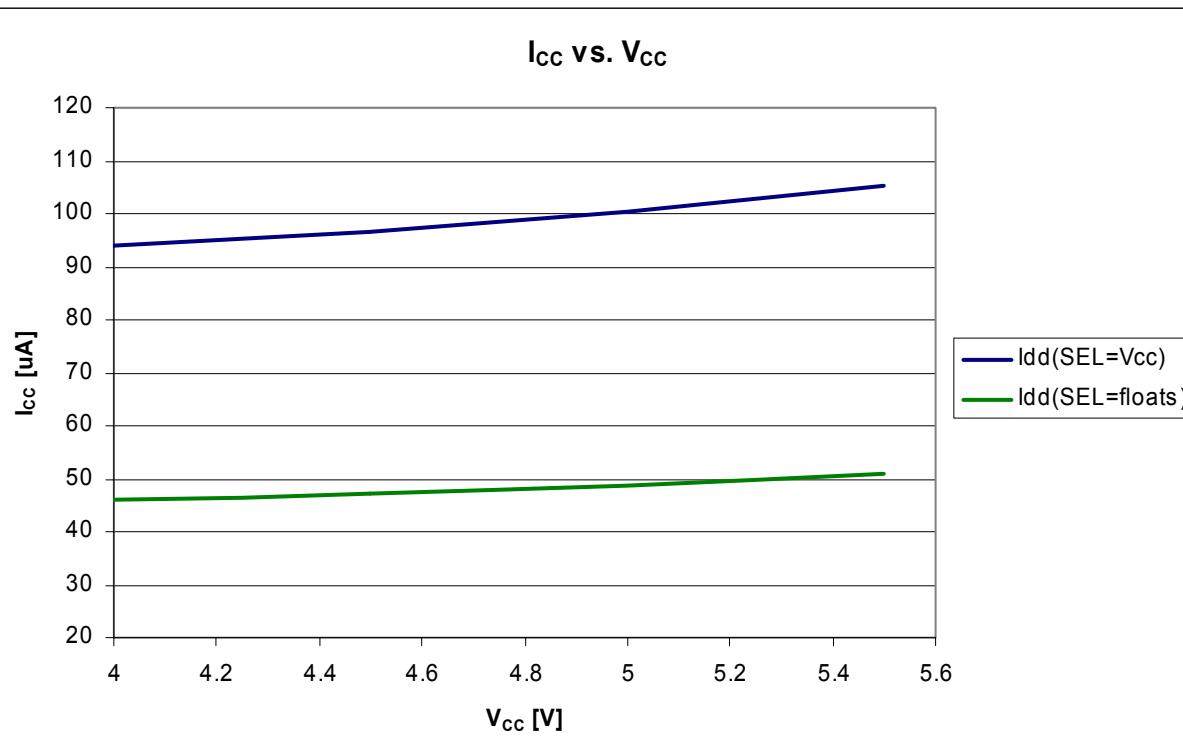
Note: The other port stays on (unless it is also in current limit.)

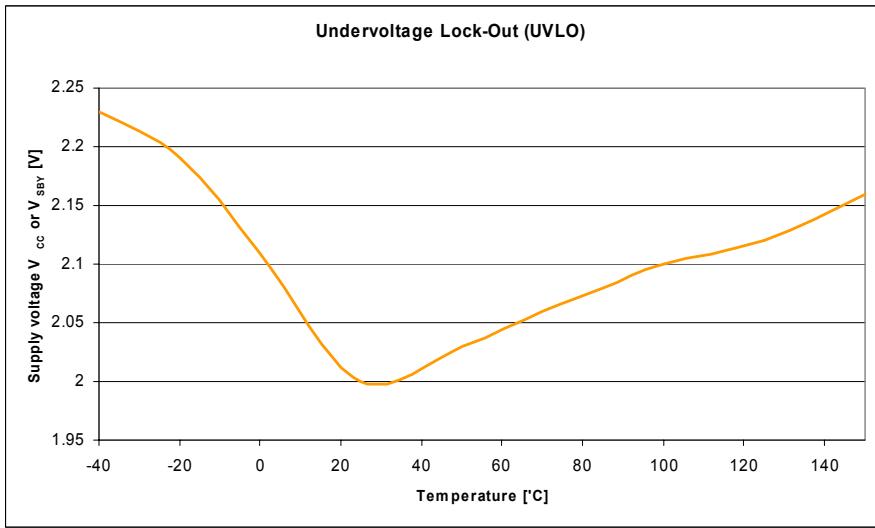
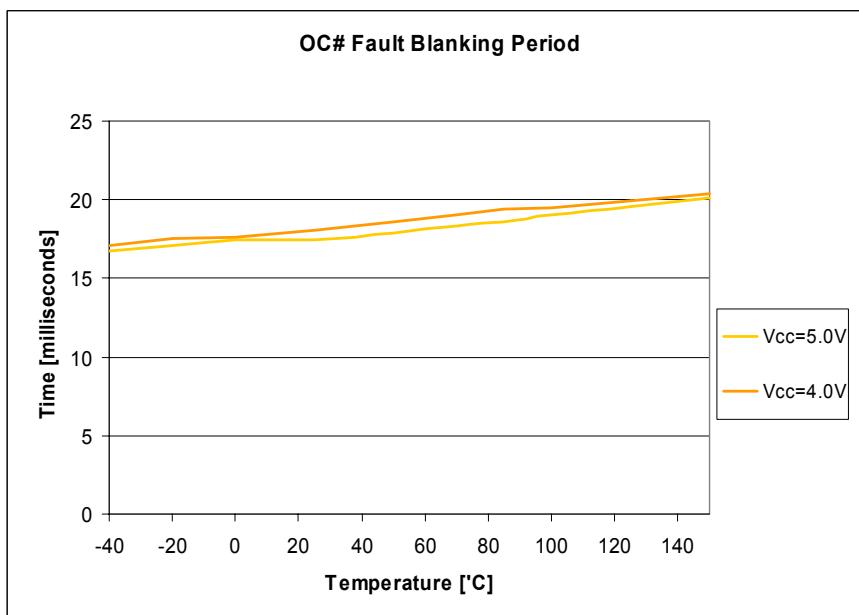
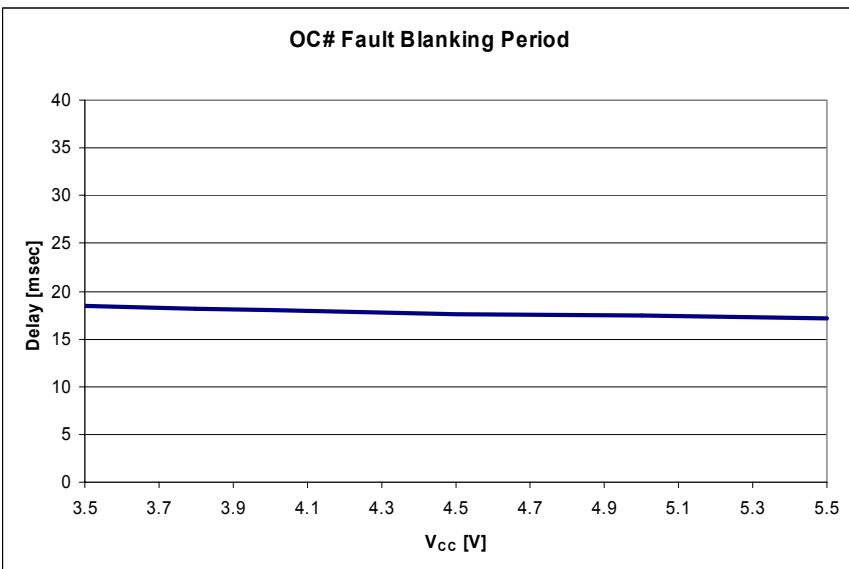


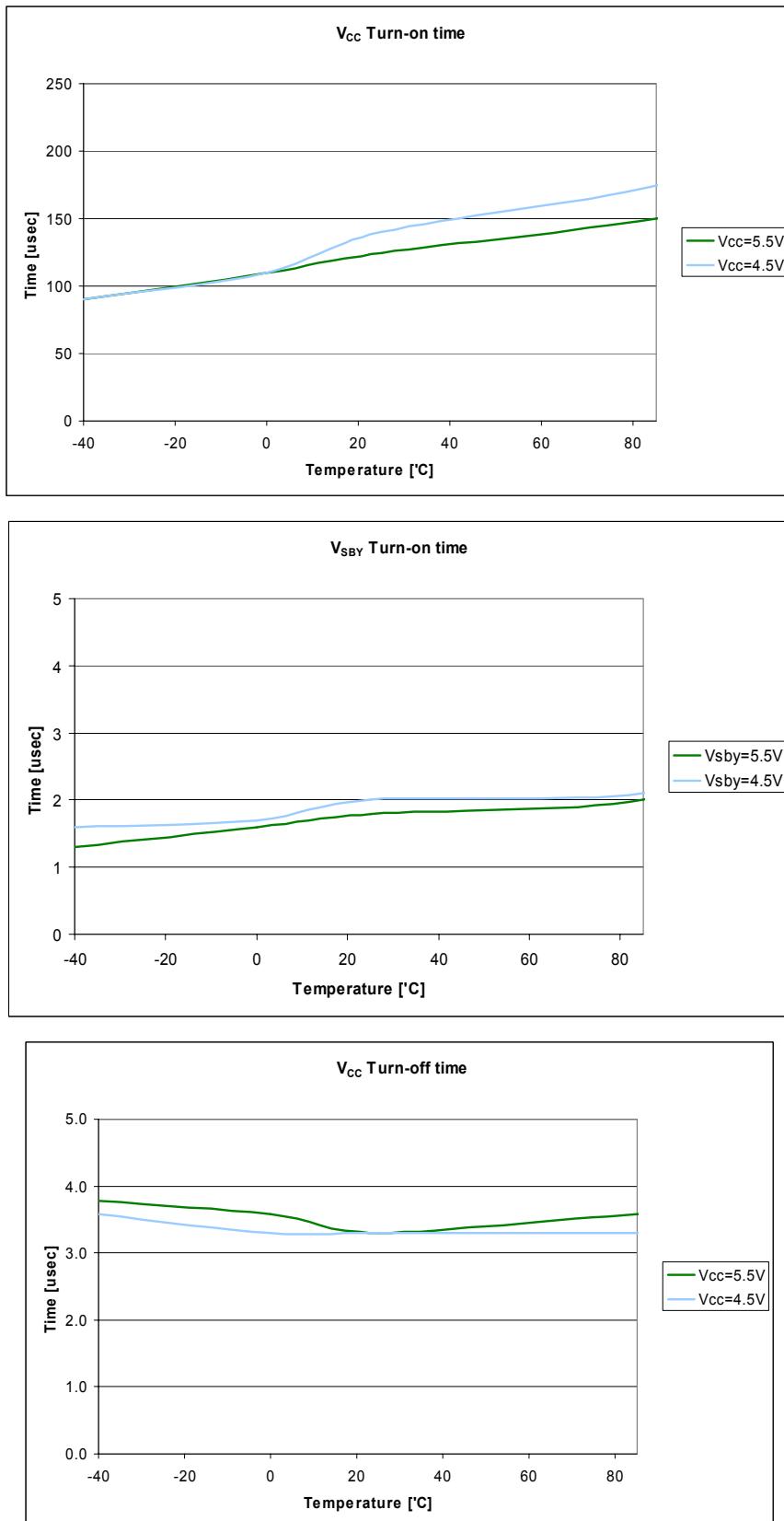
Typical Operating Characteristics

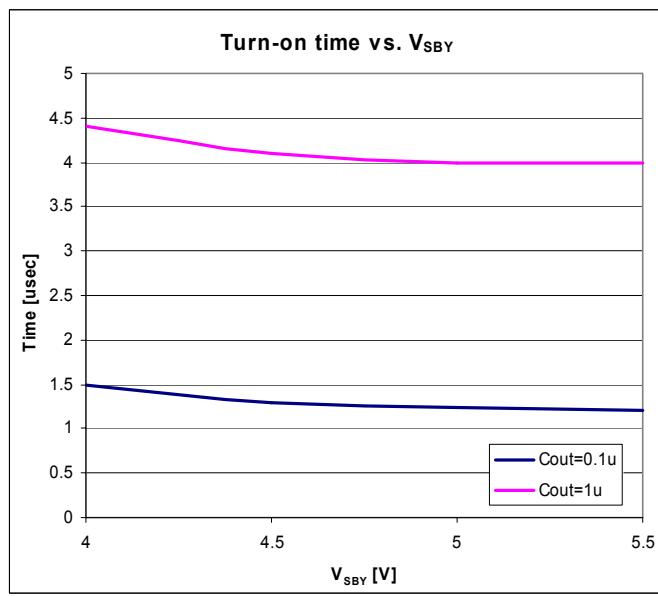
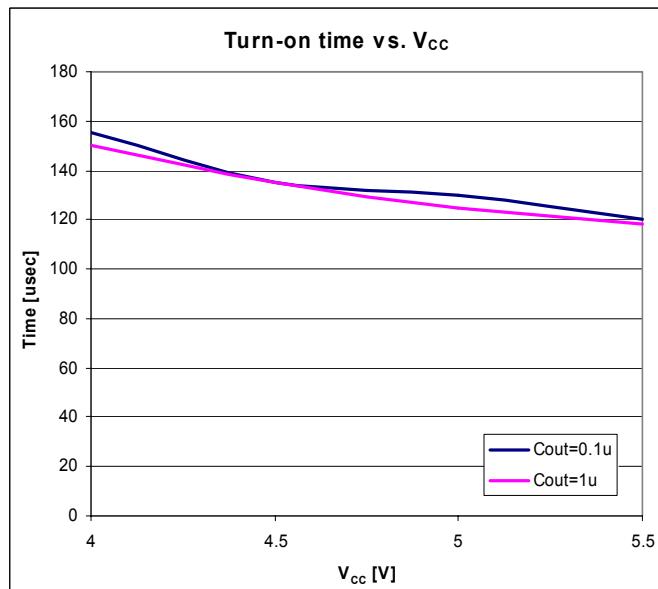
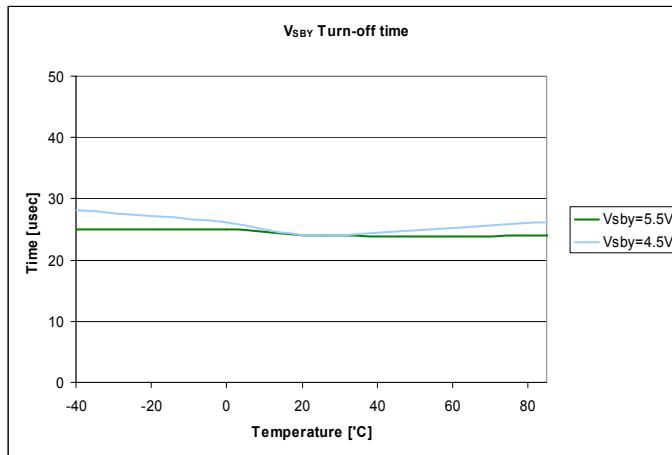


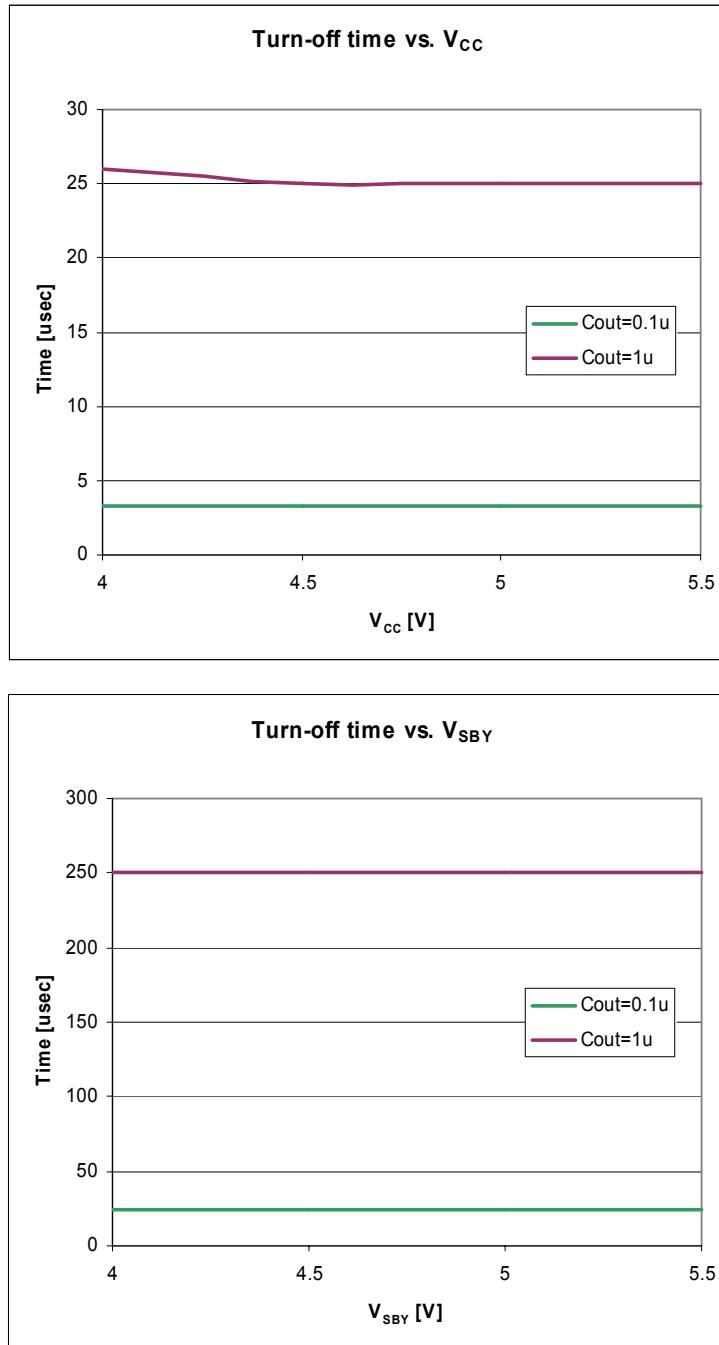


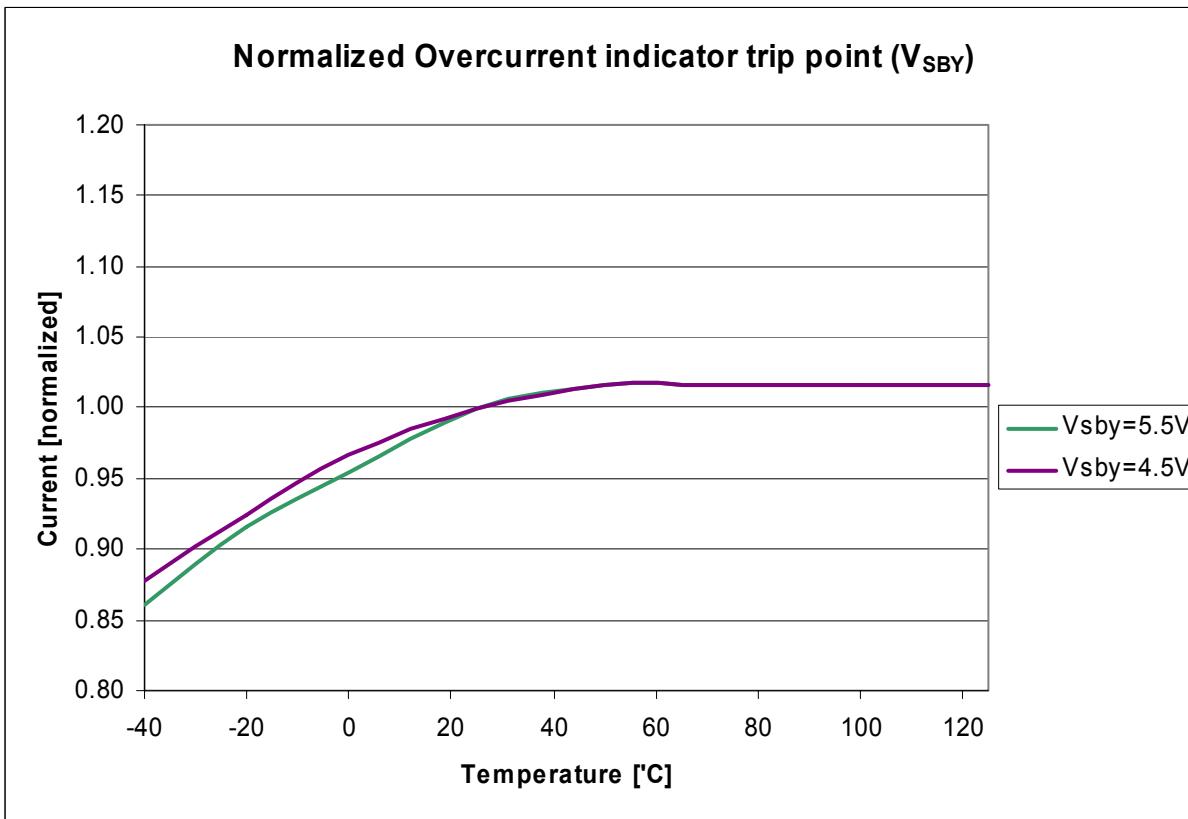
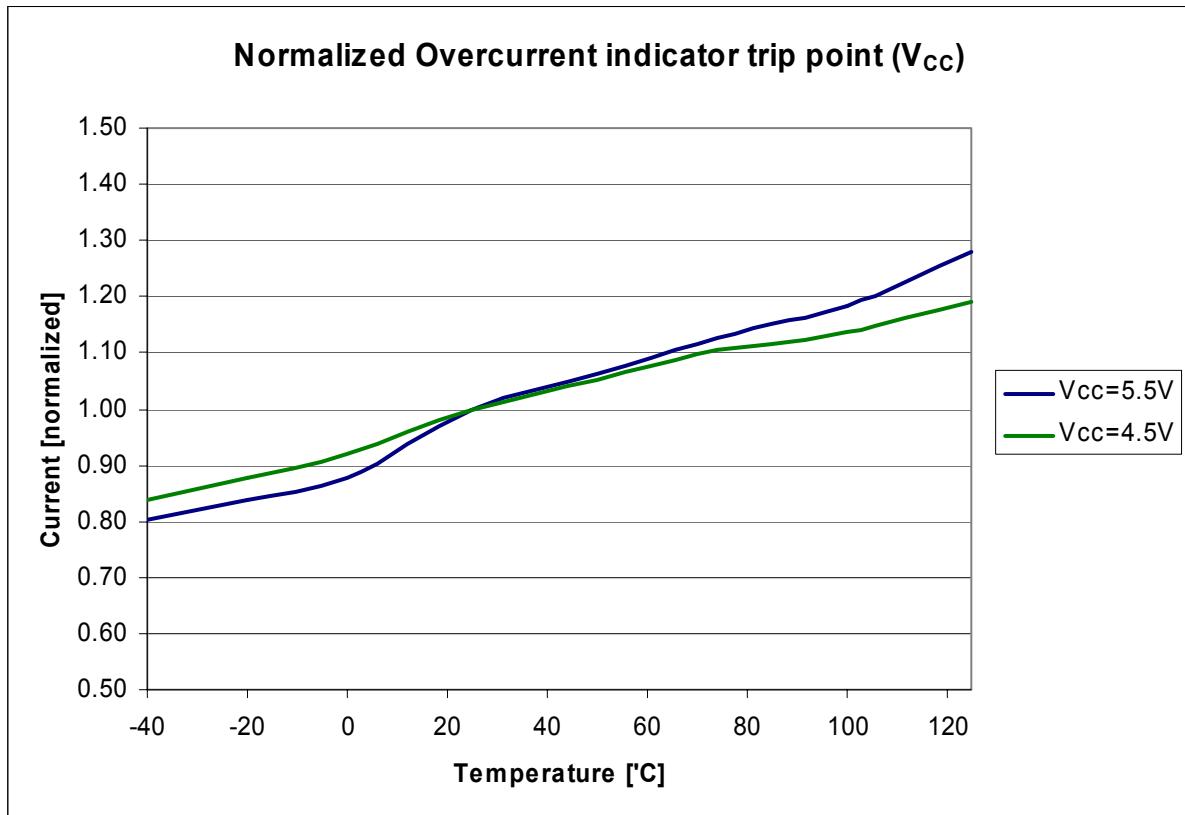














SOIC-8 Package Dimensions

